



Micropower Temperature, Power Supply and Differential Voltage Monitor

The LTC<sup>®</sup>1392 is a micropower data acquisition system

designed to measure temperature, on-chip supply voltage

and a differential voltage. The differential inputs feature

rail-to-rail common mode input voltage range. The LTC1392

contains a temperature sensor, a 10-bit A/D converter with

sample-and-hold, a high accuracy bandgap reference and

The LTC1392 can be programmed to measure ambient

temperature, power supply voltage and an external volt-

age at the differential input pins, that can also be used for

current measurement using an external sense resistor.

When measuring temperature, the output code of the A/D converter is linearly proportional to the temperature in °C.

Production trimming achieves  $\pm 2^{\circ}$ C initial accuracy at room temperature and  $\pm 4^{\circ}$ C over the full  $-40^{\circ}$ C to  $85^{\circ}$ C

The on-chip serial port allows efficient data transfer to a

wide range of MPUs over three or four wires. This,

coupled with low power consumption, makes remote location sensing possible and facilitates transmitting

a 3-wire half-duplex serial interface.

DESCRIPTION

temperature range.

data through isolation barriers.

# FEATURES

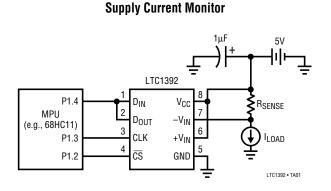
- Complete Ambient Temperature Sensor Onboard
- System Power Supply Monitor
- 10-Bit Resolution Rail-to-Rail Common-Mode Differential Voltage Input
- Available in 8-Pin SO and PDIP
- 0.2µA Supply Current When Idle
- 700µA Supply Current When Sampling at Maximum Rate
- Single Supply Voltage: 4.5V to 6V
- 3-Wire Half-Duplex Serial I/O
- Communicates with Most MPU Serial Ports and All MPU Parallel I/O Ports

# **APPLICATIONS**

- Temperature Measurement
- Power Supply Measurement
- Current Measurement
- Remote Data Acquisition
- Environment Monitoring

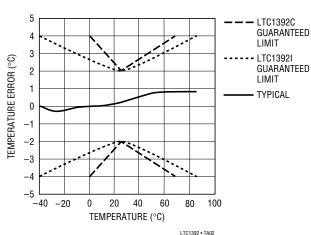
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# TYPICAL APPLICATION



**Complete Temperature, Supply Voltage and** 

#### **Output Temperature Error**



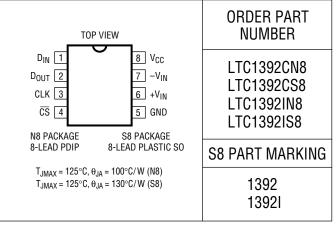


### ABSOLUTE MAXIMUM RATINGS

(Note 1)

$ \begin{array}{llllllllllllllllllllllllllllllllllll$
Operating Temperature Range LTC1392C
Storage Temperature Range –65°C to 150°C Lead Temperature (Soldering, 10 sec)

## PACKAGE/ORDER INFORMATION



Consult factory for Military grade parts.

# ELECTRICAL CHARACTERISTICS (Note 2, 3)

PARAMETER	CONDITIONS		MIN TYP	MAX	UNITS
Power Supply To Digital Conversion	· ·				
Resolution	V <sub>CC</sub> = 4.5V to 6V			10	Bit
Total Absolute Error	V <sub>CC</sub> = 4.5V to 6V	•		±8	LSB
Differential Voltage to Digital Conversion (Full-Scale Input = 1V)				·	
Resolution				10	Bit
Integral Linearity Error (Note 5)		•	±0.5	±1	LSB
Differential Linearity Error		•	±0.5	±1	LSB
Offset Error		•		±4	LSB
Full-Scale Error		•		±15	LSB
Differential Voltage to Digital Conversion (Full-Scale Input = 0.5V)		·		·	
Resolution				10	Bit
Integral Linearity Error (Note 5)		•	±0.5	±2	LSB
Differential Linearity Error		•	±0.5	±1	LSB
Offset Error		•		±8	LSB
Full-Scale Error		•		±25	LSB
Temperature to Digital Conversion					
Accuracy	$T_A = 25^{\circ}C$ (Note 7) $T_A = T_{MAX}$ or $T_{MIN}$ (Note 7)	•		±2 ±4	0° 0°
Nonlinearity	$T_{MIN} \le T_A \le T_{MAX} \text{ (Note 4)}$		±1		۵°



# ELECTRICAL CHARACTERISTICS (Note 2, 3)

SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
ION LEAKAGE	On-Channel Leakage Current (Note 6)		•			±1	μA
IOFF LEAKAGE	Off-Channel Leakage Current (Note 6)		•			±1	μA
V <sub>IH</sub>	High Level Input Voltage	V <sub>CC</sub> = 5.25V	•	2			V
V <sub>IL</sub>	Low Level Input Voltage	V <sub>CC</sub> = 4.75V	•			0.8	V
I <sub>IH</sub>	High Level Input Current	$V_{IN} = V_{CC}$	•			5	μA
IIL	Low Level Input Current	$V_{IN} = 0V$	•			-5	μA
V <sub>OH</sub>	High Level Output Voltage	V <sub>CC</sub> = 4.75V, I <sub>OUT</sub> = 10μA V <sub>CC</sub> = 4.75V, I <sub>OUT</sub> = 360μA	•	4.5 2.4	4.74 4.72		V V
V <sub>OL</sub>	Low Level Output Voltage	V <sub>CC</sub> = 4.75V, I <sub>OUT</sub> = 1.6mA	•			0.4	V
I <sub>OZ</sub>	Hi-Z Output Current	CS = High	•			±5	μA
I <sub>SOURCE</sub>	Output Source Current	V <sub>OUT</sub> = 0V			-25		mA
I <sub>SINK</sub>	Output Sink Current	V <sub>OUT</sub> = V <sub>CC</sub>			45		mA
I <sub>CC</sub>	Supply Current	$\overline{CS}$ = High $\overline{CS}$ = Low, V <sub>CC</sub> = 5V	•		0.1 0.7	5 1	μA mA
t <sub>SMPL</sub>	Analog Input Sample Time	See Figure 1			1.5		CLK Cycles
t <sub>CONV</sub>	Conversion Time	See Figure 1			10		CLK Cycles
t <sub>dDO</sub>	Delay Time, CLK $\downarrow$ to D <sub>OUT</sub> Data Valid	C <sub>LOAD</sub> = 100pF	•		150	300	ns
t <sub>en</sub>	Delay Time, CLK $\downarrow$ to D <sub>OUT</sub> Data Enabled	C <sub>LOAD</sub> = 100pF	•		60	150	ns
t <sub>dis</sub>	Delay Time, $\overline{\text{CS}} \uparrow$ to D <sub>OUT</sub> Hi-Z		•		170	450	ns
t <sub>hDO</sub>	Time Output Data Remains Valid After CLK $\downarrow$	C <sub>LOAD</sub> = 100pF			30		ns
t <sub>f</sub>	D <sub>OUT</sub> Fall Time	C <sub>LOAD</sub> = 100pF	•		70	250	ns
t <sub>r</sub>	D <sub>OUT</sub> Rise Time	C <sub>LOAD</sub> = 100pF	•		25	100	ns
C <sub>IN</sub>	Input Capacitance	Analog Input On-Channel Analog Input Off-Channel			30 5		pF pF
		Digital Input			5		pF

# **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
V <sub>CC</sub>	Supply Voltage		4.5		6	V
f <sub>CLK</sub>	Clock Frequency	$V_{CC} = 5V$	150	250	350	kHz
t <sub>CYC</sub>	Total Cycle Time	f <sub>CLK</sub> = 250kHz Temperature Conversion Only	74 144			μs μs
t <sub>hDI</sub>	Hold Time, D <sub>IN</sub> After CLK↑	$V_{CC} = 5V$	150			ns
t <sub>suCS</sub>	Setup Time $\overline{CS}\downarrow$ Before First CLK $\uparrow$ (See Figure 1)	V <sub>CC</sub> = 5V	2			μs
t <sub>WAKEUP</sub>	Wakeup Time $\overline{CS}\downarrow$ Before Start Bit <sup>↑</sup> (See Figure 1)	V <sub>CC</sub> = 5V Temperature Conversion Only	10 80			μs μs
t <sub>suDI</sub>	Setup Time, D <sub>IN</sub> Stable Before CLK↑	V <sub>CC</sub> = 5V	150			ns
t <sub>WHCLK</sub>	Clock High Time	V <sub>CC</sub> = 5V	1.6			μs
twlclk	Clock Low Time	V <sub>CC</sub> = 5V	2			μs
t <sub>WHCS</sub>	CS High Time Between Data Transfer Cycles	V <sub>CC</sub> = 5V, f <sub>CLK</sub> = 250kHz	2			μs
twlcs	CS Low Time During Data Transfer	V <sub>CC</sub> = 5V, f <sub>CLK</sub> = 250kHz Temperature Conversion Only	72 142			μs μs



## **RECOMMENDED OPERATING CONDITIONS**

The  $\bullet$  denotes specifications which apply over the operating temperature range (0°C  $\leq$  T<sub>A</sub>  $\leq$  70°C for commercial grade and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C for industrial grade).

**Note 1:** Absolute maximum ratings are those values beyond which the life of the device may be impaired.

Note 2: All voltage values are with respect to GND.

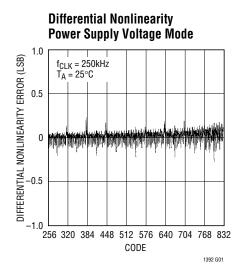
Note 3: Testing done at V<sub>CC</sub> = 5V, CLK = 250kHz and T<sub>A</sub> = 25°C unless otherwise specified.

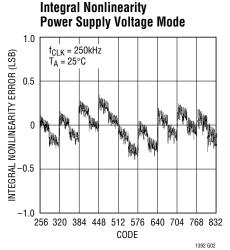
**Note 4:** Temperature integral nonlinearity is defined as the deviation of the A/D code versus temperature curve from the best-fit straight line over the device's rated temperature range.

**Note 5:** Voltage integral nonlinearity is defined as the deviation of a code from a straight line passing through the actual end points of the transfer curve.

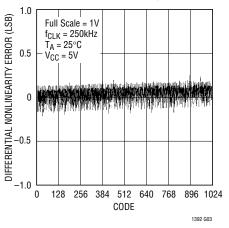
**Note 6:** Channel leakage current is measured after the channel selection. **Note 7:** See guaranteed temperature limit curves vs temperature range on the first page of this data sheet.

### **TYPICAL PERFORMANCE CHARACTERISTICS**

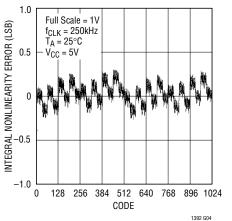




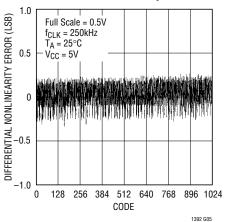
#### **Differential Nonlinearity**



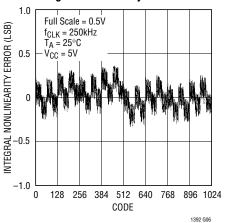




#### **Differential Nonlinearity**

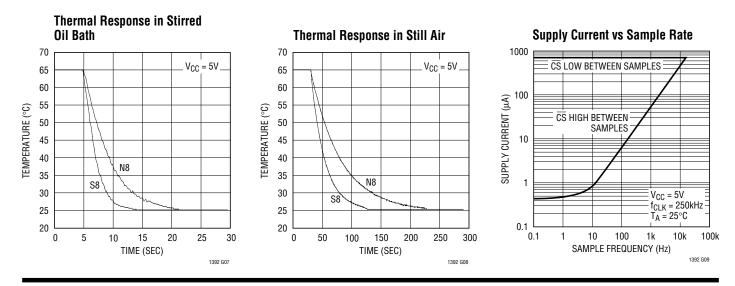


#### **Integral Nonlinearity**





## **TYPICAL PERFORMANCE CHARACTERISTICS**



### PIN FUNCTIONS

**D**<sub>IN</sub> (**Pin 1**): Digital Input. The A/D configuration word is shifted into this input.

 $\mathbf{D}_{\mathbf{OUT}}$  (Pin 2): Digital Output. The A/D result is shifted out of this output.

**CLK (Pin 3):** Shift Clock. This clock synchronizes the serial data.

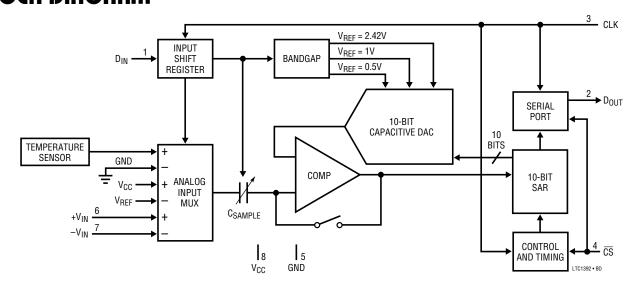
**CS** (Pin 4): Chip Select Input. A logic low on this input enables the LTC1392.

**GND (Pin 5):** Ground Pin. GND should be tied directly to an analog ground plane.

+V<sub>IN</sub> (Pin 6): Positive Analog Differential Input. The pin can be used as a single-ended input by grounding  $-V_{IN}$ .

-V<sub>IN</sub> (Pin 7): Negative Analog Differential Input. The input must be free from noise.

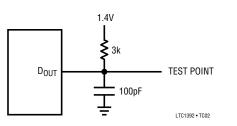
**V<sub>CC</sub> (Pin8):** Positive Supply. This supply must be kept free from noise and ripple by bypassing directly to the ground plane.



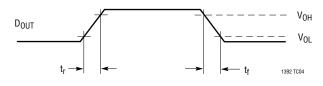
### **BLOCK DIAGRAM**

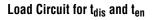
# **TEST CIRCUITS**

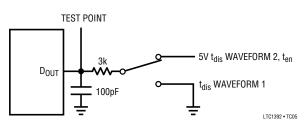
Load Circuit for  $t_{dDO}$ ,  $t_r$  and  $t_f$ 

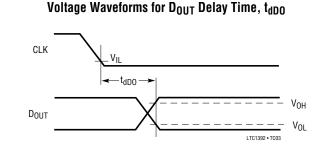


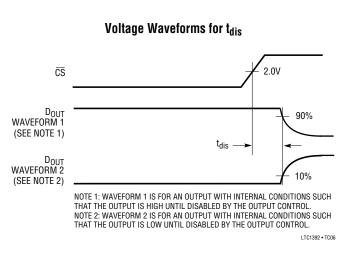
#### Voltage Waveforms for $D_{OUT}$ Rise and Fall Times, $t_{r}$ and $t_{f}$











# **APPLICATIONS INFORMATION**

The LTC1392 is a micropower data acquisition system designed to measure temperature, an on-chip power supply voltage and a differential input voltage. The LTC1392 contains the following functional blocks:

- 1. On-chip temperature sensor
- 2. 10-bit successive approximation capacitive ADC
- 3. Bandgap reference
- 4. Analog multiplexer (MUX)
- 5. Sample-and-hold (S/H)
- 6. Synchronous, half-duplex serial interface
- 7. Control and timing logic

#### **DIGITAL CONSIDERATIONS**

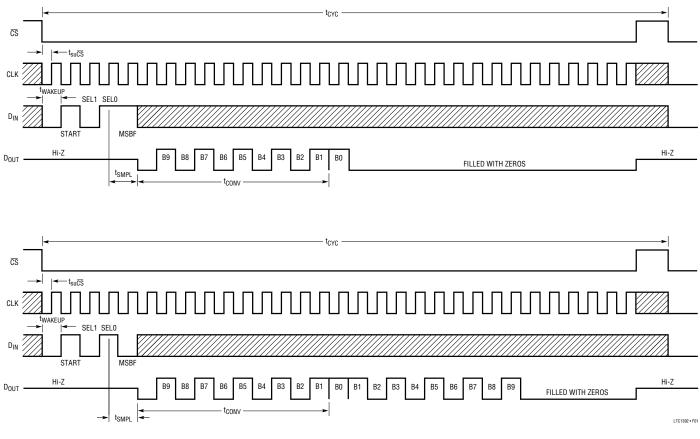
#### **Serial Interface**

The LTC1392 communicates with microprocessors and other external circuitry via a synchronous, half-duplex, 3-wire serial interface (see Figure 1). The clock (CLK) synchronizes the data transfer with each bit being transmitted on the falling CLK edge and captured on the rising CLK edge in both transmitting and receiving systems. The input data is first received and then the A/D conversion result is transmitted (half-duplex). Half-duplex operation allows D<sub>IN</sub> and D<sub>OUT</sub> to be tied together allowing transmission over three wires:  $\overline{CS}$ , CLK and DATA ( $\underline{D}_{IN}/D_{OUT}$ ). Data transfer is initiated by a falling chip select ( $\overline{CS}$ ) signal. After the falling  $\overline{CS}$  is recognized, an 80µs delay is needed for



### **APPLICATIONS INFORMATION**

MSB-First Data (MSBF = 1)



#### Figure 1

temperature measurement or a 10 $\mu$ s delay for other measurements, followed by a 4-bit input word which configures the LTC1392 for the current conversion. This data word is shifted into the D<sub>IN</sub> input. D<sub>IN</sub> is then disabled from shifting in any data and the D<sub>OUT</sub> pin is configured from three-state to an output pin. A null bit and the result of the current conversion are serially transmitted on the falling CLK edge onto the D<sub>OUT</sub> line. The format of the A/D result can be either MSB-first sequence or MSB-first sequence followed by an LSB-first serial ports. Bringing  $\overline{CS}$ high resets the LTC1392 for the next data exchange.

#### **INPUT DATA WORD**

Data transfer is initiated by a falling chip select ( $\overline{CS}$ ) signal. After  $\overline{CS}$  falls, the LTC1392 looks for a start bit. Once the start bit is received, the next three bits are shifted into the  $D_{IN}$  input which configures the LTC1392 and starts the conversion. Further inputs on the  $D_{IN}$  input are then ignored until the next  $\overline{CS}$  cycle. The four bits of the input word are defined as follows:

BIT 3	BIT 2	BIT 1	BIT O
Start	Select 1	Select 0	MSBF

#### Start Bit

The first "logic one" clocked into the  $D_{IN}$  input after  $\overline{CS}$  goes low is the Start Bit. The Start Bit initiates the data transfer and all leading zeros which precede this logical one will be ignored. After the Start Bit is received the remaining bits of the input word will be clocked in. Further input on the  $D_{IN}$  pin are then ignored until the next  $\overline{CS}$  cycle.



# **APPLICATIONS INFORMATION**

#### **Measurement Mode Selections**

The two bits of the input word following the Start Bit assign the measurement mode for the requested conversion. Table 1 shows the mode selections. Whenever there is a mode change from another mode to temperature measurement, a temperature mode initializing cycle is needed. The first temperature data measurement after a mode change should be ignored.

Table 1.	Measurement	Mode	Selections
----------	-------------	------	------------

SELECT 1	SELECT O	MEASUREMENT MODE
0	0	Temperature
0	1	Power Supply Voltage
1	0	Differential Input, 1V Full Scale
1	1	Differential Input, 0.5V Full Scale

#### MSB-First/LSB-First (MSBF)

The output data of the LTC1392 is programmed for MSB-first or LSB-first sequence using the MSBF bit. When the MSBF bit is a logical one, data will appear on the  $D_{OUT}$  line in MSB-first format. Logical zeros will be filled in indefinitely following the last data bit to accommodate longer word lengths required by some microprocessors. When the MSBF bit is a logical zero, LSB-first data will follow the normal MSB-first data on the  $D_{OUT}$  line.

### CONVERSIONS

### **Temperature Conversion**

The LTC1392 measures temperature through the use of an on-chip, proprietary temperature measurement technique. The temperature reading is provided in a 10-bit, unipolar format. Table 2 describes the exact relationship of output data to measured temperature or equation 1 can be used to calculate the temperature.

Note that the LTC1392C is only specified for operation over the 0°C to 70°C temperature range and the LTC1392I over the -40°C to 85°C range. Performance at tempera-

tures outside these specified temperature ranges is not guaranteed and errors may be greater than those shown in the Electrical Characteristics table.

•	
OUTPUT CODE	TEMPERATURE (°C)
111111111	125.75
111111110	125.50
1001101101	25.25
1001101100	25.00
1001101011	24.75
000000001	-129.75
000000000	-130.00

### Voltage Supply (V<sub>CC</sub>) Monitor

The LTC1392 measures supply voltage through the onchip V<sub>CC</sub> supply line. The V<sub>CC</sub> reading is provided in a 10-bit, unipolar format. Table 3 describes the exact relationship of output data to measured V<sub>CC</sub> or equation (2) can be used to calculate the measured V<sub>CC</sub>.

Measured $V_{CC}$ =	
[(Output Code) • 4.84/1024] + 2.42	(2)

The guaranteed supply voltage monitor range is from 4.5V to 6V. Typical parts are able to maintain measurement accuracy with  $V_{CC}$  as low as 3.25V. The typical INL and DNL error plots shown on page 4 are measured with  $V_{CC}$  from 3.63V to 6.353V.

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OUTPUT CODE	Supply Voltage (V <sub>CC</sub> )	
1011110110	6.003V	
1011110101	5.998V	
1000100010	5.001V	
0110111001	4.504V	
0110111000	4.500V	
A	*	



### **APPLICATIONS INFORMATION**

#### **Differential Voltage Conversion**

The LTC1392 measures the differential input voltage through pins +  $V_{IN}$  and - $V_{IN}$ . Input ranges of 0.5V or 1V full scale are available for differential voltage measurement with resolutions of 10 bits. Tables 4a and 4b describe the exact relationship of output data to measured differential input voltage in the 1V and 0.5V input range. Equations (3) and (4) can be used to calculate the differential voltage in the 1V and 0.5V input voltage range respectively. The output code is in unipolar format.

Differential Voltage = 1V • (10-bit code)/1024	(3)
Differential Voltage = 0.5V • (10-bit code)/1024	(4)

Table 4a. Codes for 1V Differential Voltage Range

OUTPUT CODE	INPUT Voltage	INPUT RANGE = 1V	REMARKS
1111111111	1V – 1LSB	999.0mV	
1111111110	1V – 2LSB	998.0mV	
000000001	1LSB	0.977mV	1LSB = 1/1024
0000000000	OLSB	0.00mV	

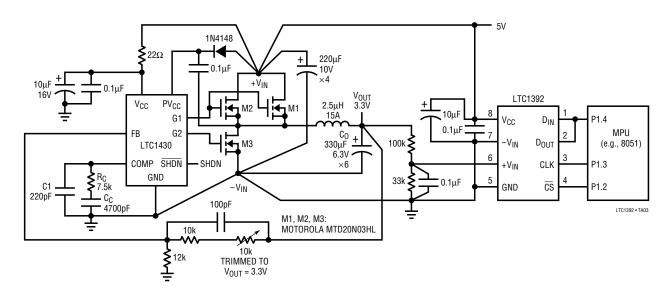
Table 4b. Codes for 0.5V Differential Voltage Range

OUTPUT CODE	INPUT Voltage	INPUT Range = 0.5V	REMARKS
1111111111	0.5V – 1LSB	499.5mV	
1111111110	0.5V – 2LSB	499.0mV	
000000001	1LSB	0.488mV	1LSB = 0.5/1024
0000000000	OLSB	0.00mV	

### **Thermal Coupling/Airflow**

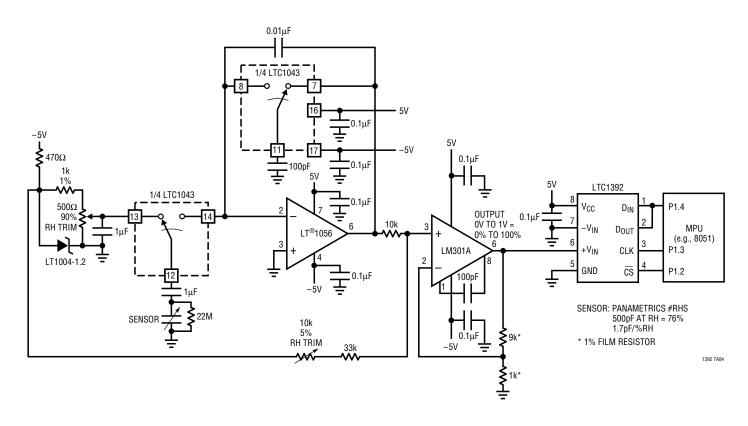
The supply current of the LTC1392 is 700µA typically when running at the maximum conversion rate. The equivalent power dissipation of 3.5mW causes a temperature rise of 0.455°C in the SO8 and 0.35°C in PDIP packages due to self-heating effects. At sampling rates less than 400 samples per second, less than 20µA current is drawn from the supply (see Typical Performance Characteristics) and the die self-heating effect is negligible. This LTC1392 can be attached to a surface (such as microprocessor chip or a heat sink) for precision temperature monitoring. The package leads are the principal path to carry the heat into the device; thus any wiring leaving the device should be held at the same temperature as the surface. The easiest way to do this is to cover up the wires with a bead of epoxy which will ensure that the leads and wires are at the same temperature as the surface. The thermal time constant of the LTC1392 in still air is about 22 seconds (see the graph in the Typical Performance Charateristics section). Attaching an LTC1392 to a small metal fin (which also provides a small thermal mass) will help reduce thermal time constant, speed up the response and give the steadiest reading in slow moving air.

# TYPICAL APPLICATIONS



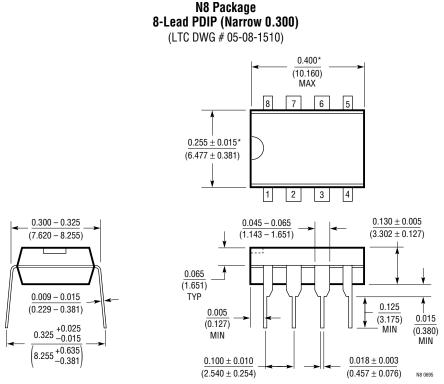
System Monitor for Two Supply Voltages and Ambient Temperature

System Monitor for Relative Humidity, Supply Voltage and Ambient Temperature



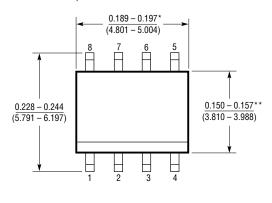


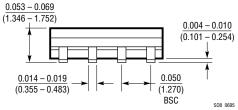
# **PACKAGE DESCRIPTION** Dimemsions in inches (millimeters) unless otherwise noted.

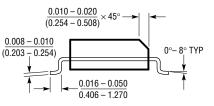


\*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm)

> S8 Package 8-Lead Plastic Small Outline (Narrow 0.150) (LTC DWG # 05-08-1610)







\*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

\*\* DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE



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